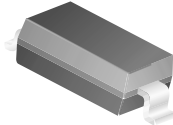


MMSD3070



SOD123
Color Band Denotes Cathode
Top Marking:
33

Small Signal Diode

Absolute Maximum Ratings* T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Maximum Repetitive Reverse Voltage	200	V
I _{F(AV)}	Average Rectified Forward Current	200	mA
I _{FSM}	Non-repetitive Peak Forward Surge Current		
	Pulse Width = 1.0 second	1.0	A
	Pulse Width = 1.0 microsecond	2.0	A
T _{stg}	Storage Temperature Range	-55 to +150	°C
T _J	Operating Junction Temperature	150	°C

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units
P _D	Power Dissipation	400	mW
R _{θJA}	Thermal Resistance, Junction to Ambient	312	°C/W

Electrical Characteristics T_A = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
V _R	Breakdown Voltage	I _R = 100 μA	200		V
V _F	Forward Voltage	I _F = 100 mA		1.0	V
I _R	Reverse Current	V _R = 175 V V _R = 175 V, T _A = 150°C		100 100	nA μA
C _T	Total Capacitance	V _R = 0, f = 1.0 MHz		5.0	pf
t _{rr}	Reverse Recovery Time	I _F = I _R = 30 mA, I _{RR} = 1.0 mA, R _L = 100 Ω		50	ns

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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
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